



- NOTE
- MATERIAL
 - HEADER : LIQUID CRYSTAL POLYMER(LCP) UL94V-0, HALOGEN FREE, COLOR OF NATURAL
 - CONTACT TERMINAL : COPPER-ALLOY, 0.3mm THICKNESS
 - PLATING
 - CONTACT TERMINAL : TIN -PLATED
 - 1.0μm MINIMUM TIN PLATING
 - PRODUCT SPECIFICATION : PS-104188-001
 - PACKAGING SPECIFICATION : PK-104188-001
 - COPLANALITY OF SOLDER TAILS (PEAK TEMP. : 260°C), BEFORE & AFTER REFLOW : 0.08 MAX.
 - APPLICABLE SOLID WIRE RANGE : AWG 24~18 (OUTSIDE WIRE INSULATION : 2.1mm DIAMETER MAX.)

PRE-RELEASE
REFERENCE
USE ONLY



194214, . . . 71
 : (+7 812) 324-63-50
 : (+7 812) 324-66-11
 E-mail: molex@ptelectronics.ru

QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	
			MM ONLY		7/1	METRIC		
▼=0 ◻=0	4 PLACES	±	±	DRAWN BY	DATE	TITLE		
	3 PLACES	±	±	JS.SHIN	2013/08/29			
	2 PLACES	± 0.15	±	CHECKED BY	DATE			
	1 PLACE	± 0.20	±	SH.CHU	2013/08/29			
	0 PLACE	±	±	APPROVED BY	DATE	MATERIAL NO. 1041880210 THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		
ANGULAR ± 1 °		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		YS00.KIM	2013/08/29			
REV	DESCRIPTION							
1	PRELIMINARY EC NO: DRWN:JSSHIN CHKD: APPR:							